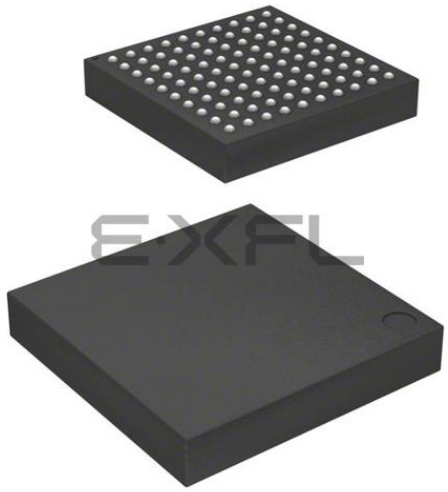
Renesas Electronics America Inc - R5F564MFHDLJ#21 Datasheet



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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	RXv2
Core Size	32-Bit Single-Core
Speed	120MHz
Connectivity	CANbus, EBI/EMI, Ethernet, I²C, LINbus, MMC/SD, SCI, SPI, SSI, UART/USART, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	78
Program Memory Size	2MB (2M x 8)
Program Memory Type	FLASH
EEPROM Size	64K x 8
RAM Size	552K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 22x12b; D/A 1x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TFLGA
Supplier Device Package	100-TFLGA (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f564mfhdlj-21

Table 1.1 Outline of Specifications (2/9)

Classification	Module/Function	Description
Clock	Clock generation circuit	• Main clock oscillator, sub clock oscillator, low-speed/high-speed on-chip oscillator, PLL frequency synthesizer, and IWDT-dedicated on-chip oscillator • The peripheral module clocks can be set to frequencies above that of the system clock. • Main-clock oscillation stoppage detection • Separate frequency-division and multiplication settings for the system clock (ICLK), peripheral module clocks (PCLKA, PCLKB, PCLKC, PCLKD), flash-IF clock (FCLK) and external bus clock (BCLK) The CPU and other bus masters run in synchronization with the system clock (ICLK): Up to 120 MHz Peripheral modules of MTU3, GPT, RSPI, SCIFA, USBA, ETHERC, EPTPC, EDMAC, and AES run in synchronization with PCLKA, which operates at up to 120 MHz. Other peripheral modules run in synchronization with PCLKB: Up to 60 MHz ADCLK in the SD12AD (unit 0) runs in synchronization with PCLKC: Up to 60 MHz ADCLK in the SD12AD (unit 1) runs in synchronization with PCLKD: Up to 60 MHz Flash IF run in synchronization with the flash-IF clock (FCLK): Up to 60 MHz Devices connected to the external bus run in synchronization with the external bus clock (BCLK): Up to 60 MHz • Multiplication is possible with using the high-speed on-chip oscillator (HOCO) as a reference clock of the PLL circuit
Reset		Nine types of reset • RES# pin reset: Generated when the RES# pin is driven low. • Power-on reset: Generated when the RES# pin is driven high and VCC = AVCC0 = AVCC1 rises. • Voltage-monitoring 0 reset: Generated when VCC = AVCC0 = AVCC1 falls. • Voltage-monitoring 1 reset: Generated when VCC = AVCC0 = AVCC1 falls. • Voltage-monitoring 2 reset: Generated when VCC = AVCC0 = AVCC1 falls. • Deep software standby reset: Generated in response to an interrupt to trigger release from deep software standby. • Independent watchdog timer reset: Generated when the independent watchdog timer underflows, or a refresh error occurs. • Watchdog timer reset: Generated when the watchdog timer underflows, or a refresh error occurs. • Software reset: Generated by register setting.
Power-on reset		If the RES# pin is at the high level when power is supplied, an internal reset is generated. After VCC = AVCC0 = AVCC1 has exceeded the voltage detection level and the specified period has elapsed, the reset is cancelled.
Voltage detection circuit (LVDA)		Monitors the voltage being input to the VCC = AVCC0 = AVCC1 pins and generates an internal reset or internal interrupt. • Voltage detection circuit 0 Capable of generating an internal reset The option-setting memory can be used to select enabling or disabling of the reset. Voltage detection level: Selectable from three different levels (2.94 V, 2.87 V, and 2.80 V) • Voltage detection circuits 1 and 2 Voltage detection level: Selectable from three different levels (2.99 V, 2.92 V, and 2.85 V) Digital filtering (1/2, 1/4, 1/8, and 1/16 LOCO frequency) Capable of generating an internal reset • Two types of timing are selectable for release from reset An internal interrupt can be requested. • Detection of voltage rising above and falling below thresholds is selectable. • Maskable or non-maskable interrupt is selectable Voltage detection monitoring Event linking
Low power consumption	Low power consumption facilities	• Module stop function • Four low power consumption modes Sleep mode, all-module clock stop mode, software standby mode, and deep software standby mode
	Battery backup function	• When the voltage on the VCC pin drops, battery power from the VBATT pin is supplied to keep the real-time clock (RTC) operating.

Table 1.1 Outline of Specifications (5/9)

Classification	Module/Function	Description
Timers	General PWM timer (GPTA)	• 16 bits × 4 channels • Counting up or down (saw-wave), counting up and down (triangle-wave) selectable for all channels • Four clock sources independently selectable for all channels (PCLKA/1, PCLKA/4, PCLKA/8, PCLKA/16) • 2 input/output pins per channel • 2 output compare/input capture registers per channel • For the 2 output compare/input capture registers of each channel, 4 registers are provided as buffer registers and are capable of operating as comparison registers when buffering is not in use. • In output compare operation, buffer switching can be at peaks or troughs, enabling the generation of laterally asymmetrically PWM waveforms. • Registers for setting up frame intervals on each channel (with capability for generating interrupts on overflow or underflow) • Synchronizable operation of the several counters • Modes of synchronized operation (synchronized, or displaced by desired times for phase shifting) • Generation of dead times in PWM operation • Through combination of three counters, generation of automatic three-phase PWM waveforms incorporating dead times • Starting, clearing, and stopping counters in response to external or internal triggers • Internal trigger sources: output of the internal comparator detection, software, and compare-match • Digital filter function for signals on the input capture and external trigger pins • Event linking by the ELC
	Programmable pulse generator (PPG)	• (4 bits × 4 groups) × 2 units • Pulse output with the MTU or TPU output as a trigger • Maximum of 32 pulse-output possible
	8-bit timers (TMRb)	• (8 bits × 2 channels) × 2 units • Select from among seven internal clock signals (PCLKB/1, PCLKB/2, PCLKB/8, PCLKB/32, PCLKB/64, PCLKB/1024, PCLKB/8192) and one external clock signal • Capable of output of pulse trains with desired duty cycles or of PWM signals • The 2 channels of each unit can be cascaded to create a 16-bit timer • Generation of triggers for A/D converter conversion • Capable of generating baud-rate clocks for SCI5, SCI6, and SCI12 • Event linking by the ELC
	Compare match timer (CMT)	• (16 bits × 2 channels) × 2 units • Select from among four internal clock signals (PCLKB/8, PCLKB/32, PCLKB/128, PCLKB/512) • Event linking by the ELC
	Compare match timer W (CMTW)	• (32 bits × 1 channel) × 2 units • Compare-match, input-capture input, and output-comparison output are available. • Select from among four internal clock signals (PCLKB/8, PCLKB/32, PCLKB/128, PCLKB/512) • Interrupt requests can be output in response to compare-match, input-capture, and output-comparison events. • Event linking by the ELC
	Realtime clock (RTCd)	• Clock sources: Main clock, sub clock • Selection of the 32-bit binary count in time count/second unit possible • Clock and calendar functions • Interrupt sources: Alarm interrupt, periodic interrupt, and carry interrupt • Battery backup operation • Time-capture facility for three values • Event linking by the ELC
	Watchdog timer (WDTA)	• 14 bits × 1 channel • Select from among 6 counter-input clock signals (PCLKB/4, PCLKB/64, PCLKB/128, PCLKB/512, PCLKB/2048, PCLKB/8192)
	Independent watchdog timer (IWDTa)	• 14 bits × 1 channel • Counter-input clock: IWDT-dedicated on-chip oscillator • Dedicated clock/1, dedicated clock/16, dedicated clock/32, dedicated clock/64, dedicated clock/128, dedicated clock/256 • Window function: The positions where the window starts and ends are specifiable (the window defines the timing with which refreshing is enabled and disabled). • Event linking by the ELC

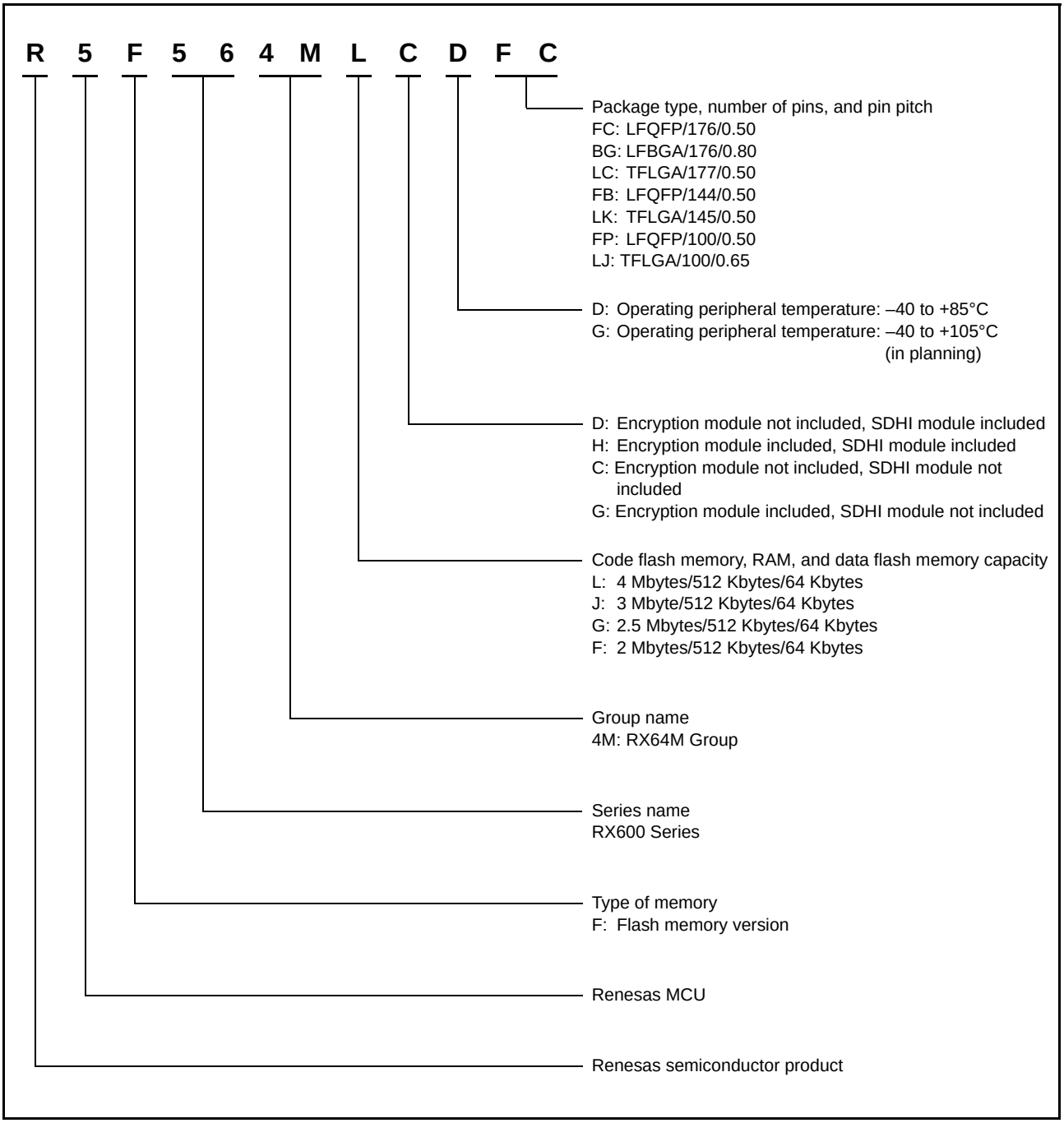
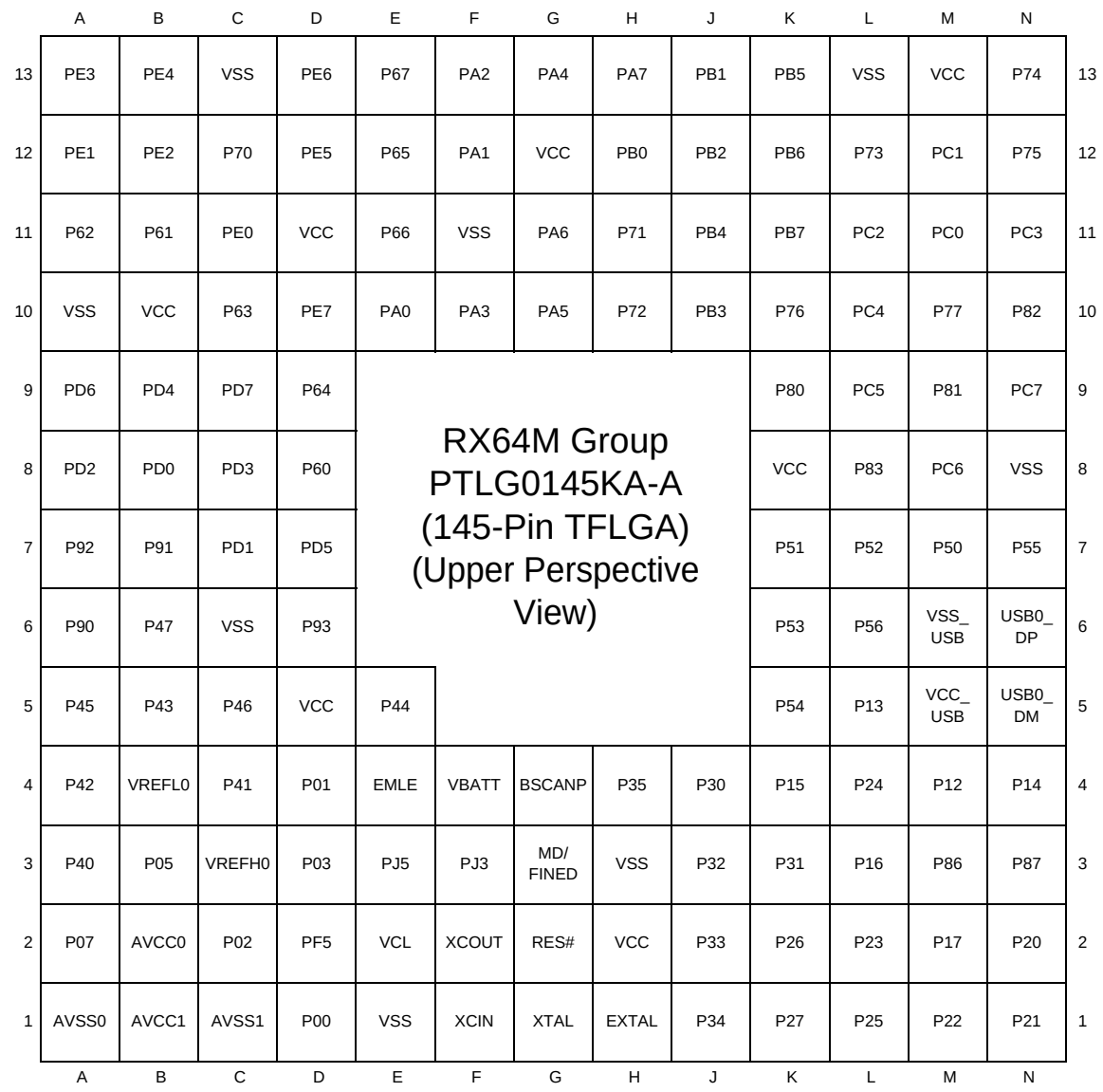


Figure 1.1 How to Read the Product Part Number



Note: This figure indicates the power supply pins and I/O port pins. For the pin configuration, see Table 1.7, List of Pin and Pin Functions (145-Pin TFLGA).

Figure 1.6 Pin Assignment (145-Pin TFLGA)

Table 1.5 List of Pin and Pin Functions (177-Pin TFLGA, 176-Pin LFBGA) (1/7)

Pin Number 177-Pin TFLGA 176-Pin LFBGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, GPT, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCIg, SCIh, RSPI, RIIC, CAN, USB, SSI)	Memory Interface Camera Interface (QSPI, SDHI, MMCIF, PDC)	Interrupt	S12ADC, R12DA
A1	AVSS0							
A2	AVCC0							
A3	VREFL0							
A4		P42					IRQ10-DS	AN002
A5		P46					IRQ14-DS	AN006
A6	VCC							
A7	VSS							
A8		P94	A20/D20		ET1_ERXD0/ RMII1_RXD0			
A9	VCC							
A10		P97	A23/D23		ET1_ERXD3			
A11		PD6	D6[A6/D6]	MTIC5V/MTIOC8A/ POE4#		MMC_D0-B/ SDHI_D0-B/ QIO0-B/ QMO-B	IRQ6	AN106
A12		P60	CS0#		ET1_TX_EN/ RMII1_TXD_EN			
A13		P63	CS3#/CAS#					
A14		PE1	D9[A9/D9]	MTIOC4C/MTIOC3B/ GTIOC1B-A/PO18	TXD12/SMOSI12/ SSDA12/TXDX12/ SIOX12	MMC_D5-B		ANEX1
A15		PE2	D10[A10/D10]	MTIOC4A/ GTIOC0B-A/PO23/ TIC3	RXD12/SMISO12/ SSCL12/ RXDX12	MMC_D6-B	IRQ7-DS	AN100
B1		P05					IRQ13	DA1
B2		P07					IRQ15	ADTRG0#
B3		P40					IRQ8-DS	AN000
B4		P41					IRQ9-DS	AN001
B5		P47					IRQ15-DS	AN007
B6		P91	A17/D17		ET1_COL/SCK7			AN115
B7		P92	A18/D18	POE4#	ET1_CRS/ RMII1_CRS_DV/ RXD7/SMISO7/SSCL7			AN116
B8		PD1	D1[A1/D1]	MTIOC4B/ GTIOC1A-E/POE0#	CTX0		IRQ1	AN109
B9		P96	A22/D22		ET1_ERXD2			
B10		PD4	D4[A4/D4]	MTIOC8B/POE11#		MMC_CMD-B/ SDHI_CMD-B/ QSSL-B	IRQ4	AN112
B11		PG1	D25		ET1_RX_ER/ RMII1_RX_ER			
B12	VSS							
B13		P64	CS4#/WE#					
B14		PE0	D8[A8/D8]	MTIOC3D/ GTIOC2B-A	SCK12	MMC_D4-B		ANEX0
B15		PE3	D11[A11/D11]	MTIOC4B/ GTIOC2A-A/PO26/ POE8#/TOC3	CTS12#/RTS12#/ SS12#/ ET0_ERXD3	MMC_D7-B		AN101
C1	AVSS1							
C2	AVCC1							
C3	VREFH0							

Table 1.6 List of Pin and Pin Functions (176-Pin LFQFP) (4/7)

Pin Number 176-Pin LFQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, GPT, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCIg, SCIh, RSPI, RIIC, CAN, USB, SSI)	Memory Interface Camera Interface (QSPI, SDHI, MMCIF, PDC)	Interrupt	S12ADC, R12DA
85		P76	CS6#	PO22	RXD11/ET0_RX_CLK/ REF50CK0	MMC_CMD-A/ SDHI_CMD-A/ QSSL-A		
86		PC2	A18	MTIOC4B/ GTIOC2B-D/TCLKA/ PO21	RXD5/SMISO5/ SSCL5/SSLA3-A/ ET0_RX_DV	MMC_CD-A/ SDHI_D3-A		
87		P75	CS5#	PO20	SCK11/RTS11#/ ET0_ERXD0/ RMII0_RXD0	MMC_RES#-A/ SDHI_D2-A		
88		P74	A20/CS4#	PO19	CTS11#/ET0_ERXD1/ RMII0_RXD1			
89		PC1	A17	MTIOC3A/TCLKD/ PO18	SCK5/SSLA2-A/ ET0_ERXD2		IRQ12	
90	VCC							
91		PC0	A16	MTIOC3C/TCLKC/ PO17	CTS5#/RTS5#/SS5#/ SSLA1-A/ET0_ERXD3		IRQ14	
92	VSS							
93		P73	CS3#	PO16	ET0_WOL			
94		PB7	A15	MTIOC3B/TIOCB5/ PO31	TXD9/ET0_CRS/ RMII0_CRS_DV			
95		PB6	A14	MTIOC3D/TIOCA5/ PO30	RXD9/ET0_ETXD1/ RMII0_TXD1			
96		PB5	A13	MTIOC2A/MTIOC1B/ TIOCB4/TMRI1/PO29/ POE4#	SCK9/RTS9#/ ET0_ETXD0/ RMII0_TXD0			
97		PB4	A12	TIOCA4/PO28	CTS9#/ET0_TX_EN/ RMII0_TXD_EN			
98		PB3	A11	MTIOC0A/MTIOC4A/ TIOCD3/TCLKD/ TMO0/PO27/POE11#	SCK4/SCK6/ ET0_RX_ER/ RMII0_RX_ER			
99		PB2	A10	TIOCC3/TCLKC/ PO26	CTS4#/RTS4#/CTS6#/ RTS6#/SS4#/SS6#/ ET0_RX_CLK/ REF50CK0			
100		PB1	A9	MTIOC0C/MTIOC4C/ TIOCB3/TMCI0/PO25	TXD4/TXD6/SMOSI4/ SMOSI6/SSDA4/ SSDA6/ET0_ERXD0/ RMII0_RXD0		IRQ4-DS	
101		P72	A19/CS2#		ET0_MDC			
102		P71	A18/CS1#		ET0_MDIO			
103	VCC							
104		PB0	A8	MTIC5W/TIOCA3/ PO24	RXD4/RXD6/SMISO4/ SMISO6/SSCL4/ SSCL6/ET0_ERXD1/ RMII0_RXD1		IRQ12	
105	VSS							
106		PA7	A7	TIOCB2/PO23	MISOA-B/ ET0_WOL			
107		PA6	A6	MTIC5V/MTCLKB/ GTETRG-C/TIOCA2/ TMCI3/PO22/POE10#	CTS5#/RTS5#/SS5#/ MOSIA-B/ ET0_EXOUT			
108		PA5	A5	MTIOC6B/ GTIOC0A-C/TIOCB1/ PO21	RSPCKA-B/ ET0_LINKSTA			
109		PA4	A4	MTIC5U/MTCLKA/ TIOCA1/TMRI0/PO20	TXD5/SMOSI5/ SSDA5/SSLA0-B/ ET0_MDC		IRQ5-DS	
110		PA3	A3	MTIOC0D/MTCLKD/ TIOCD0/TCLKB/PO19	RXD5/SMISO5/ SSCL5/ ET0_MDIO		IRQ6-DS	

Table 1.7 List of Pin and Pin Functions (145-Pin TFLGA) (1/5)

Pin Number 145-Pin TFLGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, GPT, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCIg, SCIh, RSPI, RIIC, CAN, USB, SSI)	Memory Interface Camera Interface (QSPI, SDHI, MMCIF, PDC)	Interrupt	S12ADC, R12DA
A1	AVSS0							
A2		P07					IRQ15	ADTRG0#
A3		P40					IRQ8-DS	AN000
A4		P42					IRQ10-DS	AN002
A5		P45					IRQ13-DS	AN005
A6		P90	A16		TXD7/SMOSI7/SSDA7			AN114
A7		P92	A18	POE4#	RXD7/SMISO7/SSCL7			AN116
A8		PD2	D2[A2/D2]	MTIOC4D/ GTIOC0B-E/TIC2	CRX0	MMC_D2-B/ SDHI_D2-B/ QIO2-B	IRQ2	AN110
A9		PD6	D6[A6/D6]	MTIC5V/MTIOC8A/ POE4#		MMC_D0-B/ SDHI_D0-B/ QIO0-B/ QMO-B	IRQ6	AN106
A10	VSS							
A11		P62	CS2#/RAS#					
A12		PE1	D9[A9/D9]	MTIOC4C/MTIOC3B/ GTIOC1B-A/PO18	TXD12/SMOSI12/ SSDA12/TXDX12/ SIOX12	MMC_D5-B		ANEX1
A13		PE3	D11[A11/D11]	MTIOC4B/ GTIOC2A-A/PO26/ POE8#/TOC3	CTS12#/RTS12#/ SS12#/ET0_ERXD3/	MMC_D7-B		AN101
B1	AVCC1							
B2	AVCC0							
B3		P05					IRQ13	DA1
B4	VREFL0							
B5		P43					IRQ11-DS	AN003
B6		P47					IRQ15-DS	AN007
B7		P91	A17		SCK7			AN115
B8		PD0	D0[A0/D0]	GTIOC1B-E/POE4#			IRQ0	AN108
B9		PD4	D4[A4/D4]	MTIOC8B/POE11#		MMC_CMD-B/ SDHI_CMD-B/ QSSL-B	IRQ4	AN112
B10	VCC							
B11		P61	CS1#/SDCS#					
B12		PE2	D10[A10/D10]	MTIOC4A/ GTIOC0B-A/PO23/ TIC3	RXD12/SMISO12/ SSCL12/RXDX12/	MMC_D6-B	IRQ7-DS	AN100
B13		PE4	D12[A12/D12]	MTIOC4D/MTIOC1A/ GTIOC1A-A/PO28	ET0_ERXD2			AN102
C1	AVSS1							
C2		P02		TMCI1	SCK6		IRQ10	AN120
C3	VREFH0							
C4		P41					IRQ9-DS	AN001
C5		P46					IRQ14-DS	AN006
C6	VSS							
C7		PD1	D1[A1/D1]	MTIOC4B/ GTIOC1A-E/POE0#	CTX0		IRQ1	AN109
C8		PD3	D3[A3/D3]	MTIOC8D/ GTIOC0A-E/POE8#/ TOC2		MMC_D3-B/ SDHI_D3-B/ QIO3-B	IRQ3	AN111

Table 1.10 List of Pin and Pin Functions (100-Pin LFQFP) (2/4)

Pin Number 100-Pin LFQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC	Timer (MTU, GPT, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCIg, SCIh, RSPI, RIIC, CAN, USB, SSI)	Memory Interface Camera Interface (QSPI, SDHI, MMCIF, PDC)	Interrupt	S12ADC, R12DA
30		P16		MTIOC3C/MTIOC3D/ TIOCB1/TCLKC/ TMO2/PO14/ RTCOUT	TXD1/RXD3/SMOSI1/ SMISO3/SSDA1/ SSCL3/SCL2-DS/ USB0_VBUS/ USB0_VBUSEN/ USB0_OVRCURB		IRQ6	ADTRG0#
31		P15		MTIOC0B/MTCLKB/ GTETRG-B/TIOCB2/ TCLKB/TMCI2/PO13	RXD1/SCK3/SMISO1/ SSCL1/CRX1-DS/ SSIWS1		IRQ5	
32		P14		MTIOC3A/MTCLKA/ TIOCB5/TCLKA/ TMRI2/PO15	CTS1#/RTS1#/SS1#/ CTX1/ USB0_OVRCURA		IRQ4	
33		P13		MTIOC0B/TIOCA5/ TMO3/PO13	TXD2/SMOSI2/ SSDA2/SDA0[FM+]		IRQ3	ADTRG1#
34		P12		TMCI1	RXD2/SMISO2/ SSCL2/SCL0[FM+]		IRQ2	
35	VCC_USB							
36					USB0_DM			
37					USB0_DP			
38	VSS_USB							
39		P55	WAIT#/ EDREQ0	MTIOC4D/TMO3	CRX1/ET0_EXOUT		IRQ10	
40		P54	ALE/EDACK0	MTIOC4B/TMCI1	CTS2#/RTS2#/SS2#/ CTX1/ET0_LINKSTA			
41		P53*1	BCLK					
42		P52	RD#		RXD2/SMISO2/SSCL2			
43		P51	WR1#/BC1#/ WAIT#		SCK2			
44		P50	WR0#/WR#		TXD2/SMOSI2/SSDA2			
45	UB	PC7	A23/CS0#	MTIOC3A/MTCLKB/ GTIOC3A-D/TMO2/ TOC0/PO31/CACREF	TXD8/MISOA-A/ ET0_COL		IRQ14	
46		PC6	A22/CS1#	MTIOC3C/MTCLKA/ GTIOC3B-D/TMCI2/ TIC0/PO30	RXD8/MOSIA-A/ ET0_ETXD3		IRQ13	
47		PC5	A21/CS2#/ WAIT#	MTIOC3B/MTCLKD/ GTIOC1A-D/TMRI2/ PO29	SCK8/RSPCKA-A/ RTS8#/ET0_ETXD2			
48		PC4	A20/CS3#	MTIOC3D/MTCLKC/ GTETRG-D/TMCI1/ PO25/POE0#	SCK5/CTS8#/ SSLA0-A/ ET0_TX_CLK			
49		PC3	A19	MTIOC4D/ GTIOC1B-D/TCLKB/ PO24	TXD5/SMOSI5/ SSDA5/ET0_TX_ER			
50		PC2	A18	MTIOC4B/ GTIOC2B-D/TCLKA/ PO21	RXD5/SMISO5/ SSCL5/SSLA3-A/ ET0_RX_DV			
51		PC1	A17	MTIOC3A/TCLKD/ PO18	SCK5/SSLA2-A/ ET0_ERXD2		IRQ12	
52		PC0	A16	MTIOC3C/TCLKC/ PO17	CTS5#/RTS5#/SS5#/ SSLA1-A/ET0_ERXD3		IRQ14	
53		PB7	A15	MTIOC3B/TIOCB5/ PO31	TXD9/ET0_CRS/ RMII0_CRS_DV			
54		PB6	A14	MTIOC3D/TIOCA5/ PO30	RXD9/ET0_ETXD1/ RMII0_TXD1			
55		PB5	A13	MTIOC2A/MTIOC1B/ TIOCB4/TMRI1/PO29/ POE4#	SCK9/RTS9#/ ET0_ETXD0/ RMII0_TXD0			
56		PB4	A12	TIOCA4/PO28	CTS9#/ET0_TX_EN/ RMII0_TXD_EN			

Table 4.1 List of I/O Registers (Address Order) (14 / 67)

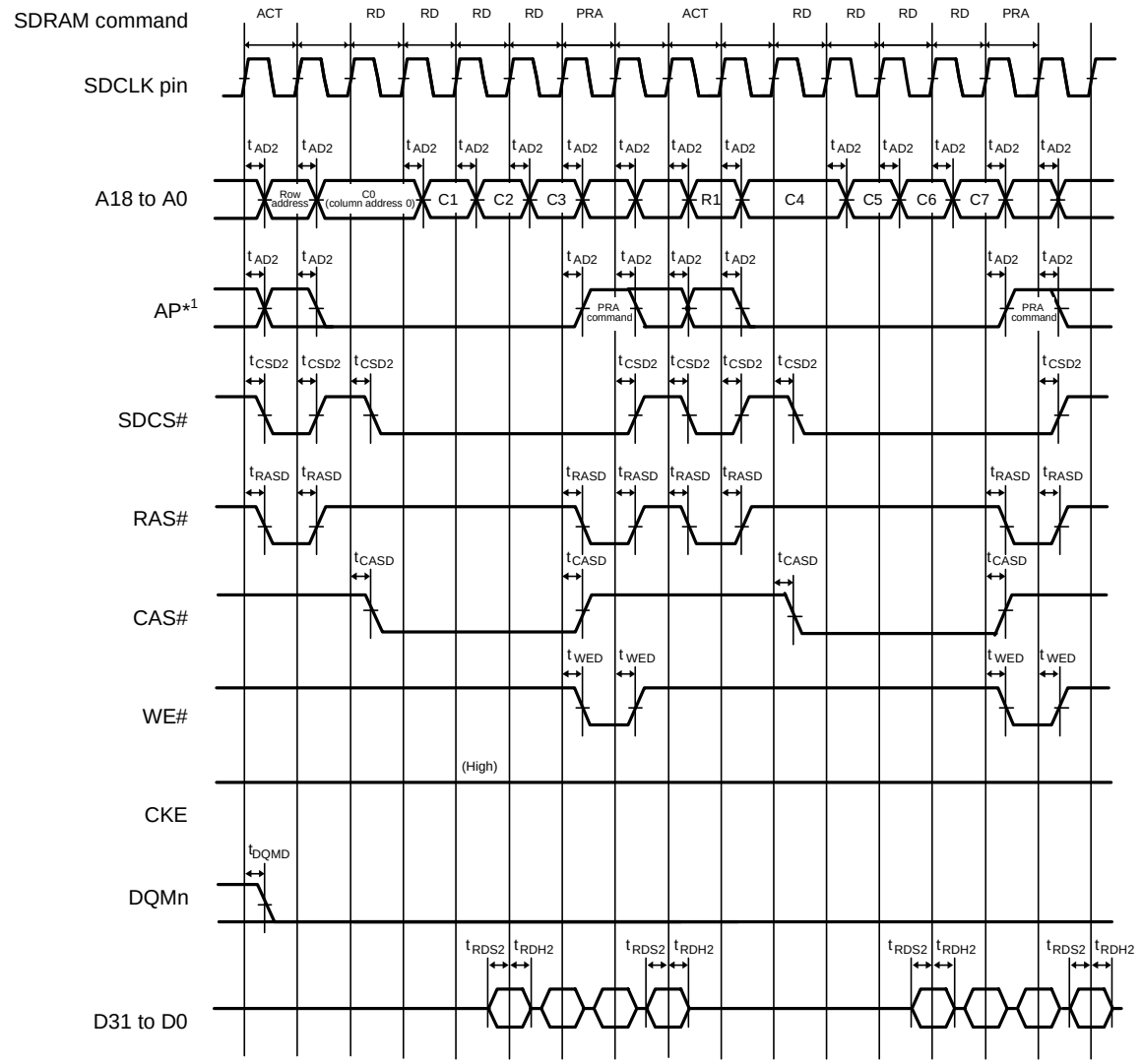
Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
0008 8022h	WDT	WDT Control Register	WDTCR	16	16	2, 3 PCLKB	2 ICLK	WDTA
0008 8024h	WDT	WDT Status Register	WDTSR	16	16	2, 3 PCLKB	2 ICLK	WDTA
0008 8026h	WDT	WDT Reset Control Register	WDTRCR	8	8	2, 3 PCLKB	2 ICLK	WDTA
0008 8030h	IWDT	IWDT Refresh Register	IWDTRR	8	8	2, 3 PCLKB	2 ICLK	IWDTa
0008 8032h	IWDT	IWDT Control Register	IWDTCR	16	16	2, 3 PCLKB	2 ICLK	IWDTa
0008 8034h	IWDT	IWDT Status Register	IWDTSR	16	16	2, 3 PCLKB	2 ICLK	IWDTa
0008 8036h	IWDT	IWDT Reset Control Register	IWDTRCR	8	8	2, 3 PCLKB	2 ICLK	IWDTa
0008 8038h	IWDT	IWDT Count Stop Control Register	IWDTCSTPR	8	8	2, 3 PCLKB	2 ICLK	IWDTa
0008 8040h	DA	D/A Data Register 0	DADR0	16	16	2, 3 PCLKB	2 ICLK	R12DA
0008 8042h	DA	D/A Data Register 1	DADR1	16	16	2, 3 PCLKB	2 ICLK	R12DA
0008 8044h	DA	D/A Control Register	DACR	8	8	2, 3 PCLKB	2 ICLK	R12DA
0008 8045h	DA	DADRm Format Select Register	DADPR	8	8	2, 3 PCLKB	2 ICLK	R12DA
0008 8046h	DA	D/A A/D Synchronous Start Control Register	DAADSCR	8	8	2, 3 PCLKB	2 ICLK	R12DA
0008 8048h	DA	D/A Output Amplifier Control Register	DAAMPCR	8	8	2, 3 PCLKB	2 ICLK	R12DA
0008 8100h	TPUA	Timer Start Register	TSTR	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8101h	TPUA	Timer Synchronous Register	TSYR	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8108h	TPU0	Noise Filter Control Register	NFCR	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8109h	TPU1	Noise Filter Control Register	NFCR	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 810Ah	TPU2	Noise Filter Control Register	NFCR	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 810Bh	TPU3	Noise Filter Control Register	NFCR	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 810Ch	TPU4	Noise Filter Control Register	NFCR	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 810Dh	TPU5	Noise Filter Control Register	NFCR	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8110h	TPU0	Timer Control Register	TCR	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8111h	TPU0	Timer Mode Register	TMDR	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8112h	TPU0	Timer I/O Control Register H	TIORH	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8113h	TPU0	Timer I/O Control Register L	TIORL	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8114h	TPU0	Timer Interrupt Enable Register	TIER	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8115h	TPU0	Timer Status Register	TSR	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8116h	TPU0	Timer Counter	TCNT	16	16	2, 3 PCLKB	2 ICLK	TPUa
0008 8118h	TPU0	Timer General Register A	TGRA	16	16	2, 3 PCLKB	2 ICLK	TPUa
0008 811Ah	TPU0	Timer General Register B	TGRB	16	16	2, 3 PCLKB	2 ICLK	TPUa
0008 811Ch	TPU0	Timer General Register C	TGRC	16	16	2, 3 PCLKB	2 ICLK	TPUa
0008 811Eh	TPU0	Timer General Register D	TGRD	16	16	2, 3 PCLKB	2 ICLK	TPUa
0008 8120h	TPU1	Timer Control Register	TCR	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8121h	TPU1	Timer Mode Register	TMDR	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8122h	TPU1	Timer I/O Control Register	TIOR	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8124h	TPU1	Timer Interrupt Enable Register	TIER	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8125h	TPU1	Timer Status Register	TSR	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8126h	TPU1	Timer Counter	TCNT	16	16	2, 3 PCLKB	2 ICLK	TPUa
0008 8128h	TPU1	Timer General Register A	TGRA	16	16	2, 3 PCLKB	2 ICLK	TPUa
0008 812Ah	TPU1	Timer General Register B	TGRB	16	16	2, 3 PCLKB	2 ICLK	TPUa
0008 8130h	TPU2	Timer Control Register	TCR	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8131h	TPU2	Timer Mode Register	TMDR	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8132h	TPU2	Timer I/O Control Register	TIOR	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8134h	TPU2	Timer Interrupt Enable Register	TIER	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8135h	TPU2	Timer Status Register	TSR	8	8	2, 3 PCLKB	2 ICLK	TPUa
0008 8136h	TPU2	Timer Counter	TCNT	16	16	2, 3 PCLKB	2 ICLK	TPUa
0008 8138h	TPU2	Timer General Register A	TGRA	16	16	2, 3 PCLKB	2 ICLK	TPUa
0008 813Ah	TPU2	Timer General Register B	TGRB	16	16	2, 3 PCLKB	2 ICLK	TPUa
0008 8140h	TPU3	Timer Control Register	TCR	8	8	2, 3 PCLKB	2 ICLK	TPUa

Table 4.1 List of I/O Registers (Address Order) (21 / 67)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
0008 9198h	S12AD1	A/D Compare Level Register 0	ADCMPLR0	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 919Ah	S12AD1	A/D Compare Level Register 1	ADCMPLR1	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 919Ch	S12AD1	A/D Compare Data Register 0	ADCMPDR0	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 919Eh	S12AD1	A/D Compare Data Register 1	ADCMPDR1	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 91A0h	S12AD1	A/D Compare Status Register 0	ADCMPSR0	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 91A2h	S12AD1	A/D Compare Status Register 1	ADCMPSR1	16	16	2, 3 PCLKB	2 ICLK	S12ADC
0008 91A4h	S12AD1	A/D Compare Status Extended Register	ADCMPSER	8	8	2, 3 PCLKB	2 ICLK	S12ADC
0008 9E00h	QSPI	QSPI Control Register	SPCR	8	8	4, 5 PCLKB	2, 3 ICLK	QSPI
0008 9E01h	QSPI	QSPI Slave Select Polarity Register	SSLP	8	8	4, 5 PCLKB	2, 3 ICLK	QSPI
0008 9E02h	QSPI	QSPI Pin Control Register	SPPCR	8	8	4, 5 PCLKB	2, 3 ICLK	QSPI
0008 9E03h	QSPI	QSPI Status Register	SPSR	8	8	4, 5 PCLKB	2, 3 ICLK	QSPI
0008 9E04h	QSPI	QSPI Data Register	SPDR	32	8, 16, 32	4, 5 PCLKB	2, 3 ICLK	QSPI
0008 9E08h	QSPI	QSPI Sequence Control Register	SPSCR	8	8	4, 5 PCLKB	2, 3 ICLK	QSPI
0008 9E09h	QSPI	QSPI Sequence Status Register	SPSSR	8	8	4, 5 PCLKB	2, 3 ICLK	QSPI
0008 9E0Ah	QSPI	QSPI Bit Rate Register	SPBR	8	8	4, 5 PCLKB	2, 3 ICLK	QSPI
0008 9E0Bh	QSPI	QSPI Data Control Register	SPDCR	8	8	4, 5 PCLKB	2, 3 ICLK	QSPI
0008 9E0Ch	QSPI	QSPI Clock Delay Register	SPCKD	8	8	4, 5 PCLKB	2, 3 ICLK	QSPI
0008 9E0Dh	QSPI	QSPI Slave Select Negation Delay Register	SSLND	8	8	4, 5 PCLKB	2, 3 ICLK	QSPI
0008 9E0Eh	QSPI	QSPI Next-Access Delay Register	SPND	8	8	4, 5 PCLKB	2, 3 ICLK	QSPI
0008 9E10h	QSPI	QSPI Command Register 0	SPCMD0	16	16	4, 5 PCLKB	2, 3 ICLK	QSPI
0008 9E12h	QSPI	QSPI Command Register 1	SPCMD1	16	16	4, 5 PCLKB	2, 3 ICLK	QSPI
0008 9E14h	QSPI	QSPI Command Register 2	SPCMD2	16	16	4, 5 PCLKB	2, 3 ICLK	QSPI
0008 9E16h	QSPI	QSPI Command Register 3	SPCMD3	16	16	4, 5 PCLKB	2, 3 ICLK	QSPI
0008 9E18h	QSPI	QSPI Buffer Control Register	SPBFCR	8	8	4, 5 PCLKB	2, 3 ICLK	QSPI
0008 9E1Ah	QSPI	QSPI Buffer Data Count Set Register	SPBDCR	16	16	4, 5 PCLKB	2, 3 ICLK	QSPI
0008 9E1Ch	QSPI	QSPI Transfer Data Length Multiplier Setting Register 0	SPBMUL0	32	32	4, 5 PCLKB	2, 3 ICLK	QSPI
0008 9E20h	QSPI	QSPI Transfer Data Length Multiplier Setting Register 1	SPBMUL1	32	32	4, 5 PCLKB	2, 3 ICLK	QSPI
0008 9E24h	QSPI	QSPI Transfer Data Length Multiplier Setting Register 2	SPBMUL2	32	32	4, 5 PCLKB	2, 3 ICLK	QSPI
0008 9E28h	QSPI	QSPI Transfer Data Length Multiplier Setting Register 3	SPBMUL3	32	32	4, 5 PCLKB	2, 3 ICLK	QSPI
0008 A000h	SCI0	Serial Mode Register	SMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A001h	SCI0	Bit Rate Register	BRR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A002h	SCI0	Serial Control Register	SCR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A003h	SCI0	Transmit Data Register	TDR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A004h	SCI0	Serial Status Register	SSR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A005h	SCI0	Receive Data Register	RDR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A006h	SMCI0	Smart Card Mode Register	SCMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A007h	SCI0	Serial Extended Mode Register	SEMR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh
0008 A008h	SCI0	Noise Filter Setting Register	SNFR	8	8	2, 3 PCLKB	2 ICLK	SCIg, SCIh

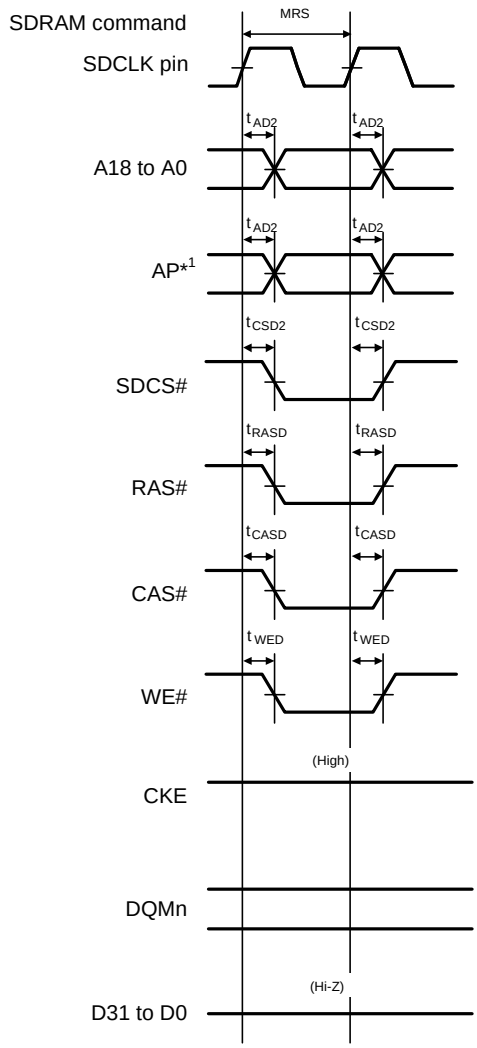
Table 4.1 List of I/O Registers (Address Order) (42 / 67)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
0009 42A0h	CMTW1	Output Compare Register 0	CMWOCR0	32	32	2, 3 PCLKB	2 ICLK	CMTW
0009 42A4h	CMTW1	Output Compare Register 1	CMWOCR1	32	32	2, 3 PCLKB	2 ICLK	CMTW
0009 8000h to 0009 D6BFh	SRC	Filter Coefficient Table	SRCFCTR0 to 5551	32	32	4, 5 PCLKB	2, 3 ICLK	SRC
0009 DFF0h	SRC	Input Data Register	SRCID	32	32	5, 6 PCLKB	2, 3 ICLK	SRC
0009 DFF4h	SRC	Output Data Register	SRCOD	32	32	5, 6 PCLKB	2, 3 ICLK	SRC
0009 DFF8h	SRC	Input Data Control Register	SRCIDCTRL	16	16	4, 5 PCLKB	2, 3 ICLK	SRC
0009 DFFAh	SRC	Output Data Control Register	SRCODCTRL	16	16	4, 5 PCLKB	2, 3 ICLK	SRC
0009 DFFCh	SRC	Control Register	SRCCTRL	16	16	4, 5 PCLKB	2, 3 ICLK	SRC
0009 DFFEh	SRC	Status Register	SRCSTAT	16	16	4, 5 PCLKB	2, 3 ICLK	SRC
000A 0000h	USB0	System Configuration Control Register	SYSCFG	16	16	3, 4 PCLKB	2 ICLK	USBb
000A 0004h	USB0	System Configuration Status Register 0	SYSSTS0	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb
000A 0008h	USB0	Device State Control Register 0	DVSTCTR0	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb
000A 0014h	USB0	CFIFO Port Register	CFIFO	16	8, 16	3, 4 PCLKB	2 ICLK	USBb
000A 0018h	USB0	D0FIFO Port Register	D0FIFO	16	8, 16	3, 4 PCLKB	2 ICLK	USBb
000A 001Ch	USB0	D1FIFO Port Register	D1FIFO	16	8, 16	3, 4 PCLKB	2 ICLK	USBb
000A 0020h	USB0	CFIFO Port Select Register	CFIFOSEL	16	16	3, 4 PCLKB	2 ICLK	USBb
000A 0022h	USB0	CFIFO Port Control Register	CFIFOCTR	16	16	3, 4 PCLKB	2 ICLK	USBb
000A 0028h	USB0	D0FIFO Port Select Register	D0FIFOSEL	16	16	3, 4 PCLKB	2 ICLK	USBb
000A 002Ah	USB0	D0FIFO Port Control Register	D0FIFOCTR	16	16	3, 4 PCLKB	2 ICLK	USBb
000A 002Ch	USB0	D1FIFO Port Select Register	D1FIFOSEL	16	16	3, 4 PCLKB	2 ICLK	USBb
000A 002Eh	USB0	D1FIFO Port Control Register	D1FIFOCTR	16	16	3, 4 PCLKB	2 ICLK	USBb
000A 0030h	USB0	Interrupt Enable Register 0	INTENB0	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb
000A 0032h	USB0	Interrupt Enable Register 1	INTENB1	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb
000A 0036h	USB0	BRDY Interrupt Enable Register	BRDYENB	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb
000A 0038h	USB0	NRDY Interrupt Enable Register	NRDYENB	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb
000A 003Ah	USB0	BEMP Interrupt Enable Register	BEMPENB	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb
000A 003Ch	USB0	SOF Output Configuration Register	SOFCFG	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb
000A 0040h	USB0	Interrupt Status Register 0	INTSTS0	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb
000A 0042h	USB0	Interrupt Status Register 1	INTSTS1	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb
000A 0046h	USB0	BRDY Interrupt Status Register	BRDYSTS	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb
000A 0048h	USB0	NRDY Interrupt Status Register	NRDYSTS	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb
000A 004Ah	USB0	BEMP Interrupt Status Register	BEMPSTS	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb
000A 004Ch	USB0	Frame Number Register	FRMNUM	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb
000A 004Eh	USB0	Device State Change Register	DVCHGR	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB)*5	USBb



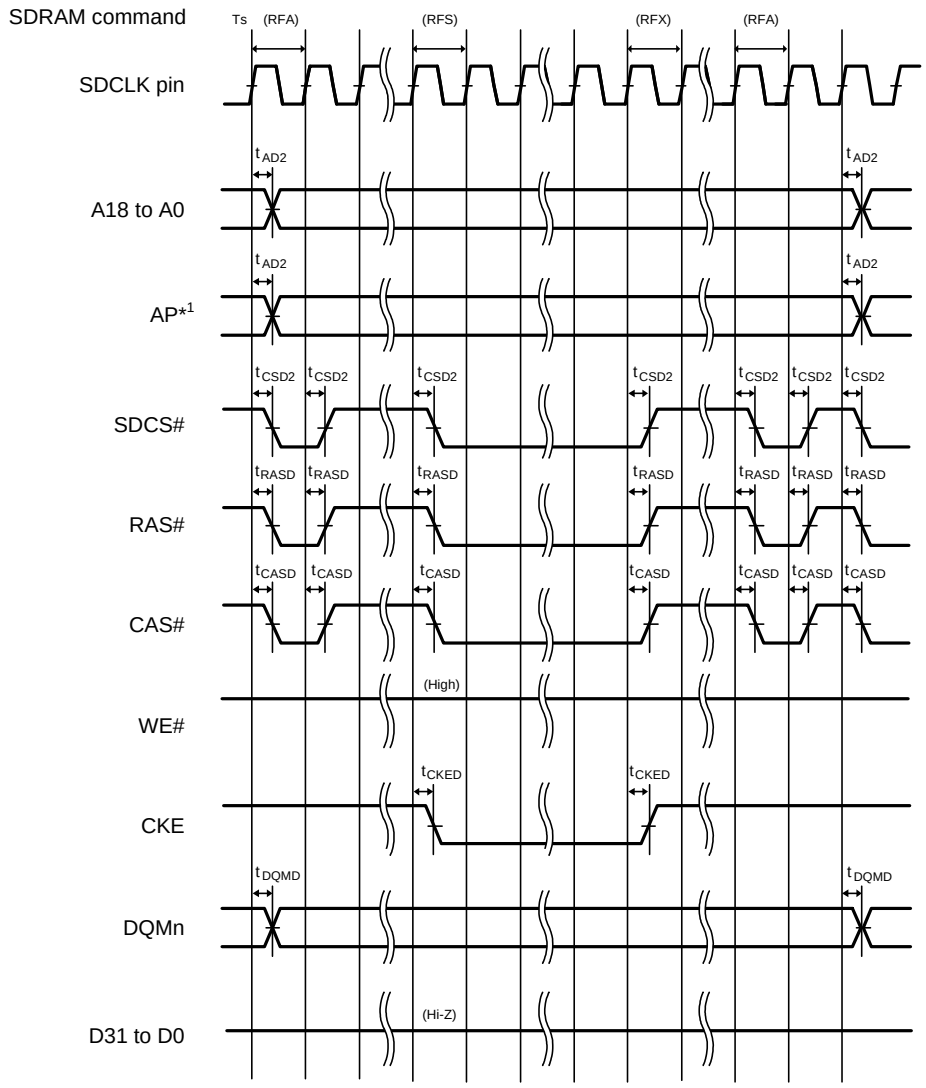
Note 1. Address pins for output of the precharge-setting command (Precharge-sel) for SDRAM.

Figure 5.27 SDRAM Space Multiple Read Line Stride Bus Timing



Note 1. Address pins for output of the precharge-setting command (Precharge-sel) for SDRAM.

Figure 5.28 SDRAM Space Mode Register Set Bus Timing



Note 1. Address pins for output of the precharge-setting command (Precharge-sel) for SDRAM.

Figure 5.29 SDRAM Space Self-Refresh Bus Timing

5.3.6 EXDMAC Timing

Table 5.22 EXDMAC Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
ICLK = PCLKA = 8 to 120 MHz, PCLKB = BCLK = SDCLK = 8 to 60 MHz, $T_a = T_{opr}$
Output load conditions: V_{OH} = VCC × 0.5, V_{OL} = VCC × 0.5, C = 30 pF
High-drive output is selected by the driving ability control register.

Item		Symbol	Min.	Max.	Unit	Test Conditions
EXDMAC	EDREQ setup time	t_{EDRQS}	13	—	ns	Figure 5.30
	EDREQ hold time	t_{EDRQH}	2	—	ns	
	EDACK delay time	t_{EDACD}	—	13	ns	Figure 5.31, Figure 5.32

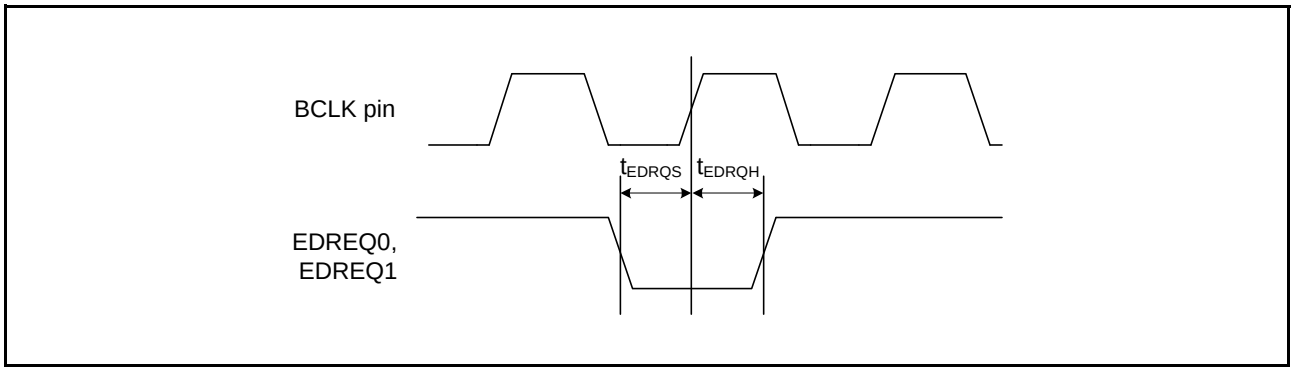


Figure 5.30 EDREQ0 and EDREQ1 Input Timing

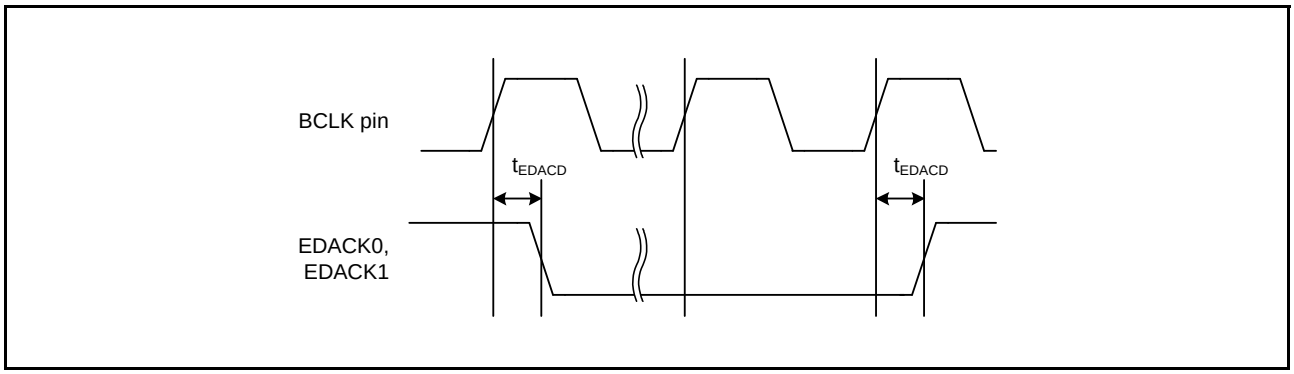


Figure 5.31 EDACK0 and EDACK1 Single-Address Transfer Timing (for a CS Area)

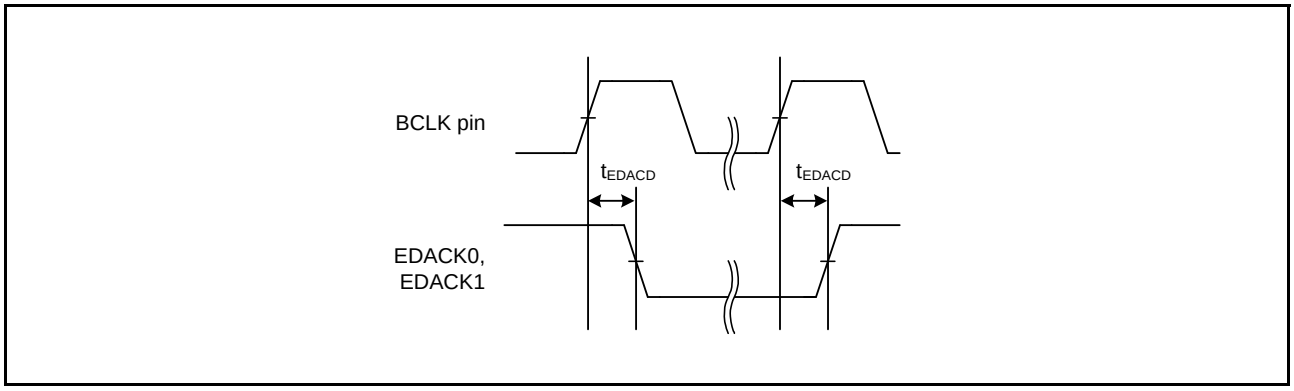


Figure 5.32 EDACK0 and EDACK1 Single-Address Transfer Timing (for SDRAM)

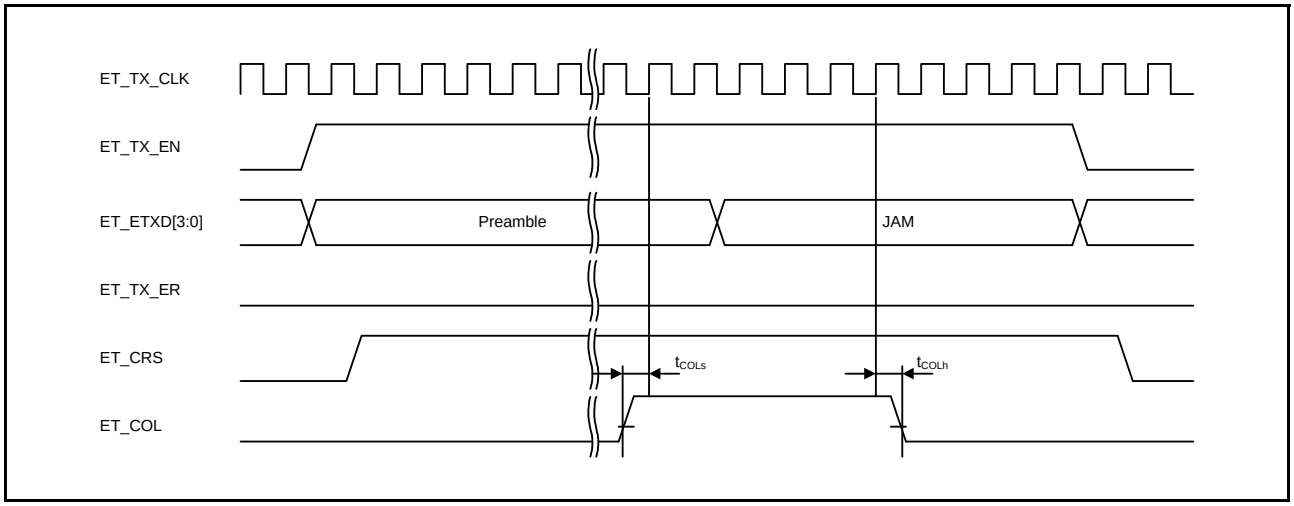


Figure 5.68 MII Transmission Timing (Conflict Occurrence)

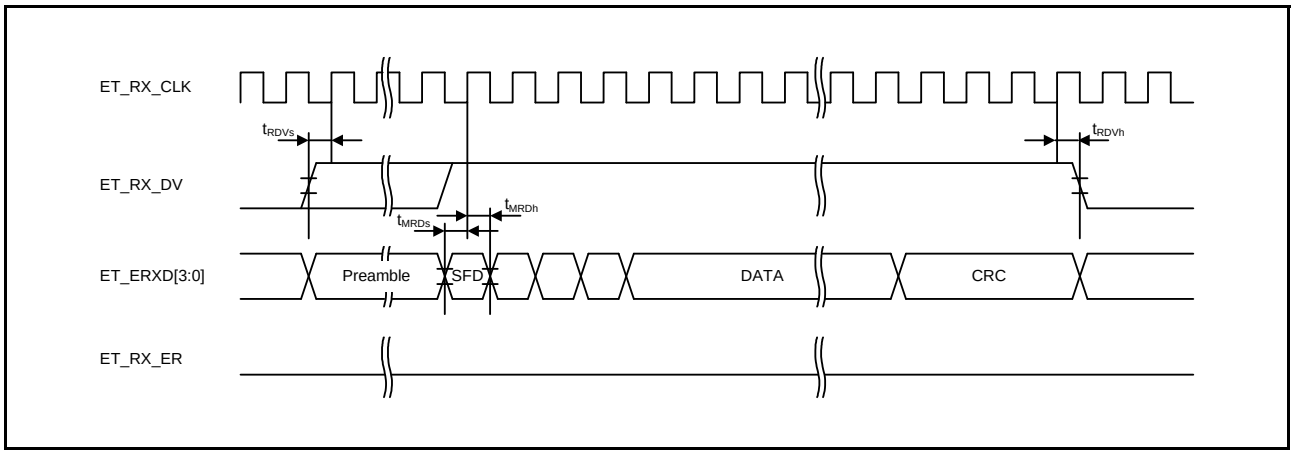


Figure 5.69 MII Reception Timing (Normal Operation)

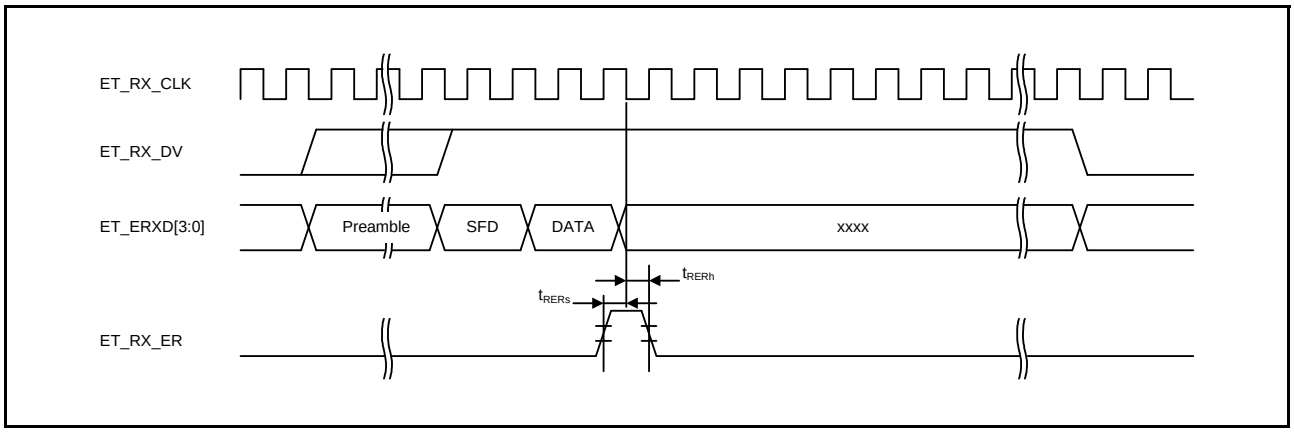


Figure 5.70 MII Reception Timing (Error Occurrence)

Table 5.44 Battery Charge Characteristics (USBA only)

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V, USBA_RREF = 2.2 kΩ ±1%, USBMCLK = 20/24 MHz, PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, $T_a = T_{opr}$

Item	Symbol	Min.	Max.	Unit	Test Conditions
D+ sink current	I_{DP_SINK}	25	175	μA	
D- sink current	I_{DM_SINK}	25	175	μA	
DCD source current	I_{DP_SRC}	7	13	μA	
Data detection voltage	V_{DAT_REF}	0.25	0.4	V	
D+ source voltage	V_{DP_SRC}	0.5	0.7	V	Output current = 250 μA
D- source voltage	V_{DM_SRC}	0.5	0.7	V	Output current = 250 μA

REVISION HISTORY	RX64M Group Datasheet

Rev.	Date	Description	
		Page	Summary
0.90	Feb 28, 2014	—	First edition, issued
1.00	Jul 31, 2014	Summary	
		1	■ Data transfer, changed
		1. Overview	
		—	FINEC (Pin), deleted
		2	Table 1.1 Outline of Specifications (1/9), changed
		3	Table 1.1 Outline of Specifications (2/9), changed
		6	Table 1.1 Outline of Specifications (5/9), changed
		7	Table 1.1 Outline of Specifications (6/9), changed
		8	Table 1.1 Outline of Specifications (7/9), changed
		9	Table 1.1 Outline of Specifications (8/9), changed
		10	Table 1.1 Outline of Specifications (9/9), changed
		16	Figure 1.1 How to Read the Product Part Number, changed
		19	Table 1.4 Pin Functions (2/8), changed
		20	Table 1.4 Pin Functions (3/8), changed
		25	Table 1.4 Pin Functions (8/8), note added
		2. CPU, added	
		3. Address Space, added	
		4. I/O Registers, added	
		5. Electrical Characteristics, added	
		Appendix 1. Package Dimensions, added	

Classifications

- Items with Technical Update document number: Changes according to the corresponding issued Technical Update
- Items without Technical Update document number: Minor changes that do not require Technical Update to be issued

Rev.	Date	Description		Classification
		Page	Summary	
1.10	Oct 24, 2016	All	Terms unified: GPTa → GPTA LQFP → LFQFP	
		Features		
		1	AES key lengths, changed	TN-RX*-A122A/E
		1. Overview		
		2	Table 1.1 Outline of Specifications (1/9), changed	TN-RX*-A127A/E
		5	Table 1.1 Outline of Specifications (4/9), changed	
		10	Table 1.1 Outline of Specifications (9/9), changed	TN-RX*-A122A/E
		28	Figure 1.5 Pin Assignment (176-Pin LFQFP), changed	
		48	Table 1.7 List of Pin and Pin Functions (145-Pin TFLGA) (2/5), changed	
		49	Table 1.7 List of Pin and Pin Functions (145-Pin TFLGA) (3/5), changed	
		52	Table 1.8 List of Pin and Pin Functions (144-Pin LFQFP) (1/5), changed	
		55	Table 1.8 List of Pin and Pin Functions (144-Pin LFQFP) (4/5), changed	
		58	Table 1.9 List of Pin and Pin Functions (100-Pin TFLGA) (2/4), changed	
		59	Table 1.9 List of Pin and Pin Functions (100-Pin TFLGA) (3/4), changed	
		63	Table 1.10 List of Pin and Pin Functions (100-Pin LFQFP) (3/4), changed	
		4. I/O Registers		
		71	(4) Notes on Sleep Mode and Mode Transitions, added	
		73	Table 4.1 List of I/O Registers (Address Order) (2 / 67) 0008 1200h, 0008 1201h, 0008 1204h, 0008 1208h, added	TN-RX*-A127A/E

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Handling of Unused Pins

   Handle unused pins in accordance with the directions given under Handling of Unused Pins in the manual.

   ¾ The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

   The state of the product is undefined at the moment when power is supplied.

   ¾ The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
   In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.
   In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

   Access to reserved addresses is prohibited.

   ¾ The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

   After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

   ¾ When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

   Before changing from one product to another, i.e. to a product with a different part number, confirm that the change will not lead to problems.

   ¾ The characteristics of Microprocessing unit or Microcontroller unit products in the same group but having a different part number may differ in terms of the internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.